

# Department of Electronics and Communication Engineering

Report of

Certification course

On

"PCB Design & Fabrication"

From 11/09/2017 to 15/09/2017

**Organized** 

in association with Armtronics

by Mr.Bavusaheb, B. K

COORDINATOR

HOD

PRINCIPAL

R.G. REDDY COLLEGE OF ENGINEERING & TECHNOLOGY

CHEKUR (V), KOINABAD, R.R. DIST.501 504. KG Reddy College of Engineering & Technology

Chikur (V) Moinabad (M).

R. R. Dist.

### Certification course on "PCB Design" from 11<sup>th</sup> to 15<sup>th</sup> of September 2017

Electronics and Communication department of K G Reddy College of engineering and technology organized Certification course on "PCB Design & Fabrication" in association with Armtronics. Course was conducted by expert, Mr Bavusaheb. B. K. 52 students from 2<sup>nd</sup> year ECE branch took part in this Course. Main focus of the Course was to do hands on practical with PCB board and designing. A Printed Circuit Board (PCB) mechanically supports and electrically connects electronic components using conductive tracks, pads and other features etched from copper sheets laminated onto a non-conductive substrate. PCBs can be single sided (one copper layer), double sided (two copper layers) or multi-layer. Conductors on different layers are connected with plated-through holes called vias. Advanced PCBs may contain components — capacitors, resistors or active devices — embedded in the substrate.

#### **DAY-1:**

In the first session students got familiar with various development boards of PCB and Learnt the development environment for PCB design. Working with PCB design was Interesting. The expert explained Schematic Design of Circuit on software KiCAD, benefits of using KiCAD, and pointers to make precise schematic design. Each & every steps and processes involved in PCB design Process has been explained by the expert.



Students listening to expert lecture

#### DAY-2

th On 12 the working of the PCB Design Schematic, auto and manual Routing of the Circuit has been performed.; a small PCB like a 4 led breakout, or a 555 timer etc, right from schematic to layout. This gives a complete flow on how to build a PCB with KiCAD. Following it we take up a advanced tutorial and do a hands on session with following topics in detail The afternoon session of Hands-on started at 1:30. P.M.,the participants are provided with laboratory sessions on Schematic design & PCB layout design on KiCAD. The participants also tried various demo circuits provided.



Explaining about KiCAD

On the 13<sup>th</sup> students learnt working with Generating Net list from schematic. It includes Annotation schemes, matching schematic symbols to footprints.



Introduction to PCB Schematic

#### DAY-4

On the 14<sup>th</sup> students learnt working of Footprints & Board layout. It includes component packages, Measurement units & standards. Library footprints, importing footprints, Creating custom footprints. Tools for footprint generation.



Working on Footprints and board layout

#### DAY-5

On the 15<sup>th</sup> students learnt working of Gerber file generation & PCB Fabrication. It includes Finalizing the design, Gerber file format for different layers, appending multiple boards. Quick Presentation on PCB fabrication, Checking FAB requirements.



Students generating files and Fabricating PCB

In the second session, we have conducted a test to evaluate and certify the students

At 4:15pm Prof. M.N.Narsaiah, HOD,ECE, KGRCET issued the certificates. He concluded by addressing the students and explained the motive behind the Course. He suggested the students to do their mini, major projects using PCB with the help of faculty members.



Ref No: KGRCET/ECE/2017-18/

#### **CIRCULAR**

Date: 08/09/2017

All the students of II B.Tech I semester ECE are here by instructed to enroll for the certification course on "PCB Design & Fabrication", which is going to conduct from 11/09/2017 to 15/09/2017. Interested students are instructed to meet respective Coordinator

HOD

HEAD

GEPY, OF ELECTRONICS & COMMUNICATIONS ENGAGERING

K.O. REDDY COLLEGE OF ENGINEERING & TECHNOLOGY

CHILKUR (V), MOIMABAO, R.R. DIBT.501 504,

Principal

KG Reddy College of Engineering & Technology
Chilkur (V) Moinabad (M).
R. R. Dist.



# Department of Electronics and Communication Engineering Certification course on PCB Design & Fabrication

S.NO	DAY 1- 11/09/2017	TIME		
1	Overview of Workshop	9:30-10:30 Am		
2	Introduction to PCB design	10:30-12:00 Pm		
3	BREAK	12:00 -1:30 Pm		
4	Introduction to KiCAD software	1:30Pm-3:00 Pm		
5	Introduction to Schematic entry to PCB layout	3:00Pm-4:15Pm		
	DAY 2 -12/09/2017			
6	Introduction to different schematic designs	9:30 AM- 11:30 AM		
7	Schematic Entry in detail	11:30Am -1:00Pm		
	LUNCH BREAK	1:00 Pm -2:30Pm		
8	Creating custom component	2:30 -3:15 Pm		
9	Importing standard libraries	3:15-3:45 Pm		
10	Matching schematic symbols to footprints	3:45 Pm-4:15pm		
	DAY 3- 13/09/2017	TIME		
11	Generating Net list from schematic	9:30-11:00Am		
12	Annotation schemes	11:00-12:30 pm		
	LUNCH BREAK	12:30 -1:30 Pm		
13	Matching schematic symbols to footprints	1:30pm-3:00pm		



	8/		
14	Tools for creating components	3:00-4:15pm	
	DAY 4- 14/09/2017	TIME	
15	Introduction to Footprints	9:30-10:00Am	
16	Component packages.	10:00-12:30 pm	
	LUNCH BREAK	12:30 -1:30 Pm	
17	Library footprints, Importing footprints.Importing Net list.	1:30pm-3:00pm	
18	Layers of design	3:00-4:15pm	
	DAY 5- 15/09/2017	TIME	
19	Introduction to file generation	9:30-10:00Am	
20	Finalizing the design	10:00-12:30 pm	
	LUNCH BREAK	12:30 -1:30 Pm	
21	Introduction to PCB Fabrication	1:30pm-3:00pm	
22	Quick Presentation on PCB fabrication	3:00-4:15pm	

HOD

PRINCIPAL

KG Redriv Schiege of Engineering & Technology
Charlett (V) Molinabed (M):



# Department of Electronics and Communication Engineering Attendance for the Certification course on "PCB Design"

S.No			Signature				
	Roll No.	Name of the Student	17/9/17	18/9/17	19/9/17	20/9/17	21/9/17
1	16QM1A0401	BALUSANI MANOJ KUMAR	my	M	M	24	M
2	16QM1A0402	BUYYAKER TARUN KUMAR	Tam	Tory	Ton	Tary	tay
3	16QM1A0403	CHANDRAGIRI CHIRANJEEVI	Out	64	Ort	Ort.	04.
4	16QM1A0404	CHEGURI SAI TEJA	dais	Seis	Soio	Lais	Lab
5	16QM1A0406	DIDDE MERCY NIHARIKA	Oct	MH	Od	004	Cont.
6	16QM1A0407	GAJJALA CHARITHA REDDY	Of	ON	CRA	Oxf	Ot.
7	16QM1A0408	GANGULA SANDEEP REDDY	Cut	Sim	Shift	Const	Cont
8	16QM1A0409	GAVVALA PAVAN KUMAR	Faren	Paux	Paux	Rus	- Rayon
9	16QM1A0410	GONGATI RASHMITHA	Day.	Story	Main	Die	Ruf
10	16QM1A0411	GORLA SHASHANK KUMAR	Ed	81	84	SI	Sil
11	16QM1A0412	GURRALA GAYATHRI PADMA KUMARI	Buch	Celu	Padu	Padue	Pade
12	16QM1A0413	JANGALI GANESH	Eks	Gay	Gar	Erg	fry
13	16QM1A0414	K SRIVIDHYA	Sy	for .	Jul	fix	Su
14	16QM1A0415	KAILASA PRIYANKA	Der	Dy	Dus	Cy	Des
15	16QM1A0416	KAKULAPATI SESHA SRIVALLI	ser 9	84	Sil	St	SI
16	16QM1A0417	KONDA AVINASH GOUD	May	401	184	AR	Hoo
17	16QM1A0418	KONIJETI VENKATESH	They	the	Shit	84	dut
18	16QM1A0419	KOTHAPALLI SRIKANTH REDDY	Pot	Not a	Dit !	RAY	
19	16QM1A0420	KUPPALA VENKATA SAI CHAITANYA	That	Shif	Ship	VI	the
20	16QM1A0421	M MANIKANTA REDDY	Mans	Men	Merain	Mand	Mario
21	16QM1A0422	MACHABHAVANA	8-4	Det.	01	of.	at
22	16QM1A0425	MULAKALA BHUVANA SATYA SAI	8+	gry .	Set	By	( Gy



23	16QM1A0426	P SAMARA SIMHA REDDY	SIMHA	SIMHA	SIMHA	SIMHA	SIMHA
24	16QM1A0427	PALNATI CHAITANYA	cha: Langa	chaltang	chaitant	chailany	chartondo
25	16QM1A0428	PANGANURU NARESH PHOKRAN	Hange	Morred	Namedo	Nanell	Narests
26	16QM1A0429	PANTHAM KEERTHI	X291	Key	Level	Len	Level
27	16QM1A0431	R SIMRAN	Sime	Sime	Rim	Sinas	Rimi
28	16QM1A0432	RAJPUT ADITYA SINGH	Shilye	Addy	Adity	Alitia	Aditya
29	16QM1A0433	RAMAIAH SUPRIYA	Suprier	Supris	Sulmiyo	· Supring	<u>Rupriya</u>
30	16QM1A0434	RANGAREDDY SAHITHI	Salutia	Sahithi	Salithi	Saliti	Sahithi
31	16QM1A0435	S SAI SRIVASTHAVA NAIDU	400	ga .	900	EXP.	BO
32	16QM1A0436	SARVIGARI YESHWANTH SIMHA REDDY	Sam	Sur	Soure	800	8min
33	16QM1A0438	TALAKANTI MADHURI	Madhum	Madlier	Matheri	Modern	adhuri
34	16QM1A0439	TANISHQ CHOUDHARY	Sand	Land	Sout.	Jans	Sand
35	16QM1A0440	TIPPANI KRANTHI KUMAR REDDY	Kraula	Kradi	Evaille	Kvaale	Kvathi
36	16QM1A0441	TOTA NARENDRA	Noved	(Na)	Non	Rad	Das
37	16QM1A0442	VOOTKURI SUDHIR GOUD	SA	188	(3)	83	384

Coordinator

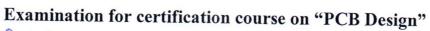
HOD HEAD Manopelera. PRINCIPAL

ELPT OF ELECTIONICS ECONMUNICATIONS ENGINESPING IPT OF LECTHOMICS & COMMODING PRINCIPAL RECEIVED BY TECHNOLOGY Principal

K.A. KENDY COLLEGE OF ENGINE PRINCIPAL RECEIVED & Technology

CHUNCE (V), MONMODING R.R. GESTSCHOOL KG Reddy College of Engineering & Technology

Chilkur (V) Moinabad (M), R. R. Dist





Roll no: 160MIA0425 Name of the student:

Buvana.

1. Which among the	ne below mentioned packag	es does not belong to the categ	gory of A	
'Small Outline P	ackage'?	COM		
		SOT	SON	
due to immersion	n of wire or sheet metal spe	d out for the generation of solo ecimen in a bath of molten solo	der sample [B]	
a. Solder Bath Testing	b. Meniscus Rise Testing	c. Solder Iron Testing	d. None of the above	
3. Which among the Frequency Resista	below stated soldering me ance Soldering'?	thods is also renowned as 'Hig	h [C]	
a. Iron Soldering	b. Furnace Soldering	c. Torch Soldering	d. Electrical Soldering	
4. Which among the Testing?	e below mentioned approac	hes belongs to the category of	In-circuit D	
a. Impedance Testing	b. Component Testing	c. Apply Signal and check output	d. All of the above	
5. High current circ accordance to the		or placed near the edge of PCB	in [ ]	
a. Removal of				
heat	stray current			
6. What is/are the ne	ecessity/ies to provide guard	ding to precision differential an	mplifiers? [ [ ]	
a. To increase leakage resistance	The state of the s			
		rcuit paths of lowest impedances for shielding purposes?	ces [D]	
a. Radiation	b. Convection	c. Noise	d. Crosstalk	
	e below specified assertions DC as well as DAC?	s is not a grounding considerat	ion	
a. Analog side to analog ground	b. Digital side to digital ground		d. Reduction of inductive loop area between power and return traces	
mechanism using	logic flow in opposite direction of the logical PCB designing?	is precise in the crosstalk verification with the limit of avoiding	g dangerous	
a. $Z_{\text{even}} > Z_{\text{odd}}$	b. $Z_{odd} \ge 0.5 Z_{even}$	c. $Z_{odd} \ge 0.8 Z_{even}$	d. $Z_{\text{odd}} = Z_{\text{even}}$	
What should be the thickness of stand	ne resistance of 0.6 mm wide ard copper foil? (Assume p	de conductor with 15 cm length $0 = 1.7241 \times 10^{-6} (at 20^{\circ} C)$	h and 25 μm	

a. 118.2 mΩ	b. 138.2 mΩ	c. 172.4 mΩ	d. 192.4 ms2				
11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1							
What effects can be observed if the separate power and ground planes are provided  [A ]							
with large conducting surfaces for better decoupling in PCB layouts?  a Increase in self-  b. Reduction in self-  c. Stability in self-inductance d. None of the above							
Ci. III	b. Reduction in self-	c. Stability in soil inductance					
inductance	inductance	ring on component side in ord	er to avoid	[0]			
Which type of PC	B requires illiminum soluc	ing on component side in side					
replacement orient	1. Dauble sided PCP	c. Both a and b	d. None of	the above			
a. Single-sided PCB	b. Double-sided PCB	c. Both a and o					
		-					
13 Which factors con	atribute to the occurrence o	f mechanical stress?		[8]			
13 Which factors con	itribute to the occurrence of	i meenamear sa ess.					
a. Resonance	b. Cracked Solder Joints	c. Both a and b	d. None of	the above			
a. Resoliance	o. Clacked Solder verille						
14 he actual cost of P	CB can be evaluated on the	e basis of					
1. He detadi cost of 1			1 11 01	7			
a. PCB size &	b. Number of layers	c. Vias on PCB	d. All of th	e above			
material				F 03			
Which terminolog	gy of PCB represents a thin	photo-sensitive polymer by su	pporting				
	ern of single traces or IC pa	ads for etching?	1.0.11	1			
a. Prepreg	b. Etching	c. Photo-resist	d. Solder n	nask			
			14:	[/]			
16 Which among the	below mentioned assertion	ns is not a way of cross-talk rec	luction	1			
while designing digital PCBs?  a Decrease in the  b Shielding of clock  c. Reduction in the loop area d. Avoid running of							
a. Decrease in the	b. Shielding of clock	c. Reduction in the loop area		unning of aces for longer			
distance between	lines with guard strips	of circuits		especially for			
conductors				ous signals			
17 Which among the below stated devices/equipments are preferred for elimination							
which among the	of ground and supply line noise especially in TTL/CMOS / ECL PCB designing?						
or ground and su	ppry line noise especially in	a Crubbar aircuits	d. All of th	na abova			
a. Coupling capacitor	b. Decoupling capacitor	c. Shubber circuits	u. All of th	ie above			



### CERTIFICATE

Name: RANGAREDDY SAHITHI

Registration No: 16QM1A0434

has successfully completed the prescribed requirements for the award of Certification course on "PCB Design & Fabrication" conducted by department of Electronics and Communication Engineering held in month of September from 11/09/2017 to 15/09/2017 in the academic year 2017-2018.

Date: 15/09/2017

Bow.

**Course Coordinator** 



Principal



## CERTIFICATE

Name: SARVIGARI YESHWANTH SIMHA REDDY

Registration No: 16QM1A0436

has successfully completed the prescribed requirements for the award of Certification course on "PCB Design & Fabrication" conducted by department of Electronics and Communication Engineering held in month of September from 11/09/2017 to 15/09/2017 in the academic year 2017-2018.

Date: 15/09/2017

Bavu.

**Course Coordinator** 



AND .

Principal